Benvenuto in O-Leading

Siamo produttori di PCB professionali con oltre dieci anni di esperienza. Gamma di prodotti: PCB singolo, doppio lato, multistrato, PCB flessibile e MCPCB. Siamo in grado di fornire un servizio prototipo rapido: S / S in 24 ore, 4-8 giocatori in 48-96 ore lavorative di produzione.
(Produttore di tavole di rame pesante Cina)

LAMIERA FORI RAME MINIMO .025 AVG, .020 MIN. I FORI NON POSSONO ESSERE COLLEGATI

Confezione con pellicola a bolle trasparente incolore, 25 pezzi / sacchetto, mettere l'essiccante nel fianco, mettere la scheda dell'indicatore di umidità sul lato superiore

FARE CLIC SU QUESTI PER MAGGIORI INFORMAZIONI PCB con riempimento all'ingrosso di rame

Descrizione del prodotto

P / N PCB	Q508756-C
Conteggio dei livelli	2L
Materiale	Ceramica di base
Board thk	0.50 millimetri
thk di rame	1 / 1oz
Dimensione del foro più piccola	1,6 millimetri
Numero di fori (pezzi)	4
linea w / s	1.27mm
iomcontrollo della pedanza. S / N (% Tol)	N
Finitura superficiale	ENIG
Maschera per saldatura Serigrafia	N / A
Dimensioni scheda singola	Dim X (mm): 50; Dim Y (mm): 55
Panelisation	Dim X (mm): 50; Dim Y (mm): 55; No di UPS: 1
Speciale: maschera pelabile	N
Routing / Punzonatura	CNC

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Produttore di PCB a base di rame Cina

FAQ

1. In che modo O-Leading garantisce la qualità?
Il nostro elevato standard di qualità è raggiunto con quanto segue.
1.Il processo è rigorosamente controllato secondo gli standard ISO 9001: 2008.
2. Ampio utilizzo del software nella gestione del processo di produzione
3. Attrezzature e strumenti di collaudo all'avanguardia. Per esempio. Sonda volante, ispezione a raggi X, AOI (Automated Optical Inspector) e ICT (test in-circuit).
4.Dedicato team di controllo qualità con processo di analisi dei casi di fallimento
5. Formazione e formazione continua del personale

2. In che modo O-Leading mantiene il tuo prezzo competitivo?
Nell'ultimo decennio, i prezzi di molte materie prime (ad es. Rame, prodotti chimici) sono raddoppiati, triplicati o quadruplicati; La valuta cinese RMB si è apprezzata del 31% rispetto al dollaro USA; E anche il nostro costo del lavoro è aumentato in modo significativo. Tuttavia, O-Leading ha mantenuto i nostri prezzi costanti. Questo appartiene interamente alle nostre innovazioni nel ridurre i costi, evitare gli sprechi e migliorare l'efficienza. I nostri prezzi sono molto competitivi nel settore allo stesso livello di qualità.
Crediamo in una partnership vantaggiosa per tutti con i nostri clienti. La nostra partnership sarà reciprocamente vantaggiosa se possiamo offrirti un vantaggio in termini di costi e qualità.

3. Quali tipi di schede possono elaborare O-Leading?
Schede comuni FR4, high TG e senza alogeni, Rogers, Arlon, Telfon, schede a base di alluminio / rame, PI, ecc.

4. Quali dati sono necessari per la produzione di PCB?
È meglio fornire i dati nel formato Gerber 274-X. Inoltre, è possibile elaborare anche Cam350, CAD, Protel 99se, PADS, DXP ed Eagle.

5. Qual è il flusso di processo tipico per PCB multistrato?
Taglio del materiale → Pellicola asciutta interna → attacco interno → AOI interno → Multi-bond → Strato impilato verso l'alto Premendo → Foratura → PTH → Placcatura pannello → Pellicola asciutta esterna → Placcatura modello → Incisione esterna → AOI esterno → Maschera saldante → Contrassegno componente → Finitura superficiale → Instradamento → E / T → Controllo visivo.

La nostra squadra

Factory PCB

Automatic vacuum press machine

Drilling Machine

Pattern Plating Machine

Scrubbing Machine

Developing Machine

Routing Machine

High-speed flying probe machine

E-test Machine

Factory SMT

certificazioni

CICC CERTIFICATION
嘉泰认证

QUALITY MANAGEMENT SYSTEM CERTIFICATE

Certificate No: 18118Q10347R0S

We hereby certify that

O-LEADING SUPPLY CHAIN(HK) CO.,LIMITED

Credit No：61691591-000-07-18-7

Registration Add: FLAT/RM 1205 12/F TAI SANG BANK BUILDING 130-132 DES VOEUS ROAD CENTRAL HK

Business Add: 1313, Floor 13, Fortune Building, Danshui Town, Huiyang District, Huizhou, Guangdong, China

Has implemented and maintains a **Quality Management System**

Which fulfils the requirements of the following standards

GB/T19001-2016 idt ISO9001:2015

Scope of certification

Sales of printed circuit boards

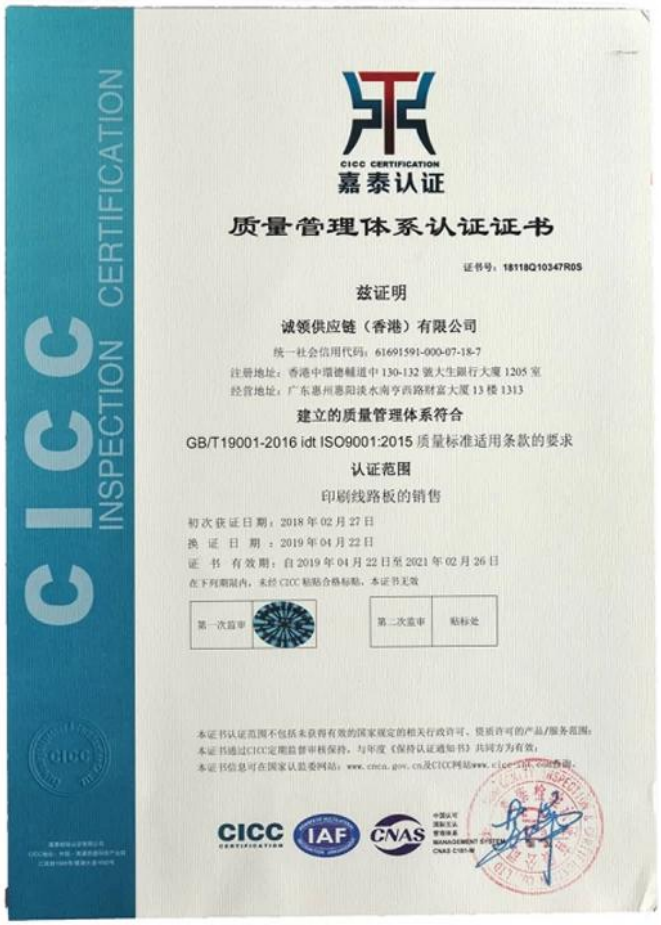
Initial Issuance period: February 27, 2018

Renewal date: April 22, 2019

This certificate is valid during: April 22, 2019 ～ February 26, 2021

This certificate is invalid without CICC qualified label in the following period

First supervision and audit		Second supervision and audit	Qualified mark



CICC CERTIFICATION
嘉泰认证

质量管理体系认证证书

证书号：18118Q10347R0S

兹证明

诚领供应链（香港）有限公司

统一社会信用代码：61691591-000-07-18-7

注册地址：香港中環德輔道中 130-132 號大生銀行大廈 1205 室

经营地址：广东惠州惠阳淡水南亨西路财富大厦 13 楼 1313

建立的质量管理体系符合

GB/T19001-2016 idt ISO9001:2015 质量标准适用条款的要求

认证范围

印刷线路板的销售

初次获证日期：2018 年 02 月 27 日

换 证 日 期 ：2019 年 04 月 22 日

证 书 有效期：自 2019 年 04 月 22 日至 2021 年 02 月 26 日

在下列期限内，未经 CICC 贴贴合格标贴，本证书无效

第一次监审		第二次监审	贴标处

O-LEADING SUPPLY CHAIN (HK) CO.,LIMITED

1313,FLOOR 13, FORTUNE BUILDING, DANSHUI TOWN, HUIYANG DISTRICT, HUIZHOU, GUANGDONG, CHINA

The following sample(s) was/were submitted and identified on behalf of the clients as : OSP

SGS Job No. :	RP19-005089 - SZ
Date of Sample Received :	22 Mar 2019
Testing Period :	22 Mar 2019 - 30 Mar 2019
Test Requested :	Selected test(s) as requested by client.
Test Method :	Please refer to next page(s).
Test Results :	Please refer to next page(s).
Conclusion :	Based on the performed tests on submitted sample(s), the results of Lead, Mercury, Cadmium, Hexavalent chromium, Polybrominated biphenyls (PBBs), Polybrominated diphenyl ethers (PBDEs) and Phthalates such as Bis(2-ethylhexyl) phthalate (DEHP) , Butyl benzyl phthalate (BBP), Dibutyl phthalate (DBP) , and Diisobutyl phthalate (DIBP) comply with the limits as set by RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU.

Signed for and on behalf of
SGS-CSTC Standards Technical Services Co., Ltd. Shenzhen Branch

Tina

Tina Fan
Approved Signatory

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Attention: To check the authenticity of testing /inspection report & certificate, please contact us at telephone: (86-755) 8307 1443, or email: CN.Doucheck@sgs.com
SGS-CSTC Standards Technical Services Co., Ltd. Shenzhen Branch
SGS Bldg, No.2, Jianghai Industrial Park, No.858, Jihua Road, Bantian, Longgang District, Shenzhen, China 518129 t (86 - 755) 25328888 f (86 - 755) 83106190 www.sgsgroup.com.cn
中国 · 深圳 · 龙岗区坂田吉华路430号江灏工业园4栋SGS大楼 邮编: 518129 t (86 - 755) 25328888 f (86 - 755) 83106190 e sgs.china@sgs.com
Member of the SGS Group (SGS SA)

Test Results :

Test Part Description :

Specimen No.	SGS Sample ID	Description
SN1	SZX19-005304.001	Green"PCB"

Remarks :

(1) 1 mg/kg = 1 ppm = 0.0001%
(2) MDL = Method Detection Limit
(3) ND = Not Detected (< MDL)
(4) "-" = Not Regulated

RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU

Test Method : With reference to IEC 62321-4:2013+A1:2017, IEC62321-5:2013, IEC62321-7-2:2017, IEC 62321-6:2015 and IEC62321-8:2017, analyzed by ICP-OES, UV-Vis and GC-MS.

Test Item(s)	Limit	Unit	MDL	001
Cadmium (Cd)	100	mg/kg	2	ND
Lead (Pb)	1,000	mg/kg	2	8
Mercury (Hg)	1,000	mg/kg	2	ND
Hexavalent Chromium (Cr(VI))	1,000	mg/kg	8	ND
Sum of PBBs	1,000	mg/kg	-	ND
Monobromobiphenyl	-	mg/kg	5	ND
Dibromobiphenyl	-	mg/kg	5	ND
Tribromobiphenyl	-	mg/kg	5	ND
Tetrabromobiphenyl	-	mg/kg	5	ND
Pentabromobiphenyl	-	mg/kg	5	ND
Hexabromobiphenyl	-	mg/kg	5	ND
Heptabromobiphenyl	-	mg/kg	5	ND
Octabromobiphenyl	-	mg/kg	5	ND
Nonabromobiphenyl	-	mg/kg	5	ND
Decabromobiphenyl	-	mg/kg	5	ND
Sum of PBDEs	1,000	mg/kg	-	ND
Monobromodiphenyl ether	-	mg/kg	5	ND
Dibromodiphenyl ether	-	mg/kg	5	ND
Tribromodiphenyl ether	-	mg/kg	5	ND
Tetrabromodiphenyl ether	-	mg/kg	5	ND
Pentabromodiphenyl ether	-	mg/kg	5	ND

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UL Product iQ™

ZPMV2.E490354 - WIRING, PRINTED - COMPONENT

Wiring, Printed - Component

See General Information for Wiring, Printed - Component

O-LEADING SUPPLY CHAIN (HK) CO LTD E490354
ROOM 1205, 12/F
TAI SANG BANK BLDG
130-132 DES VOEUS ROAD
CENTRAL, HONG KONG

Type	Cond Width Min mm(in)	Cond Width Min Edge mm(in)	Cond Thk mic(mil)	SS/ DS/ DSO	Max Area Diam mm(in)	Solder Limits C	Solder Limits sec	Max Oper Temp C	Flame Class	Meets UL796 DSR	CTI
Multilayer (mass laminate) printed wiring boards.											
O-LEADING-401	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	12.7 (0.5)	260	10	130	V-0	-	-
O-LEADING-407	0.08 (0.003)	0.2 (0.008)	17 (0.67)	DS	9.7 (0.4)	260	10	130	V-0	All	-
Multilayer printed wiring boards.											
O-LEADING-408	0.125 (0.005)	0.125 (0.005)	12 (0.47) Int:136	DS	50.8 (2.0)	280	20	130	V-0	All	*
Single layer printed wiring boards.											
O-LEADING-002	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	105	V-0	All	-
O-LEADING-003	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	130	V-0	▲	-
O-LEADING-033	0.15 (0.006)	0.3 (0.012)	34 (1.34)	SS	25.4 (1.0)	260	10	120	V-0	All	-
O-LEADING-205	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	69.6 (2.7)	260	10	130	V-0	All	-
O-LEADING-206	0.15 (0.006)	0.33 (0.013)	17 (0.67)	DS	69.6 (2.7)	260	10	130	V-0	All	-
O-LEADING-D01	0.14 (0.006)	0.15 (0.006)	33 (1.30)	DS	25.4 (1.0)	260	10	130	V-0	All	*
O-LEADING-S01	0.25 (0.010)	0.25 (0.010)	17 (0.67)	SS	25.4 (1.0)	260	4	130	V-0	All	*

WIRING, PRINTED - COMPONENT | UL Product iQ

O-LEADING-S02	0.2 (0.008)	0.2 (0.008)	17 (0.67)	SS	25.4 (1.0)	260	4	130	HB	▲	*
O-LEADING-S03	0.25 (0.010)	0.25 (0.010)	34 (1.34)	SS	25.4 (1.0)	260	4	130	V-0	All	*

* - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or burning test classification.

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Imballaggio e consegna

Quick Turn Lead Time		
Layer Count:	Lead Tim	Special Requirement
1L/2L	2-3days	24 Hours,48 Hours
4L	3-4days	48 Hours
6L	4-5days	72 Hours
8L	5-6days	NA
10L	6-7days	NA
12L	7-8days	NA
14L	8-9days	NA

Standard Lead Time		
Layer Count:	Sample Lead Time	Volume order lead time
2L	4 days	10 days
4L	5 days	11 days
6L	6 days	12 days
8L	8 days	14 days
10L	10 days	16 days
12L	12 days	18 days
14L	14 days	20 days
16-32L	18 days	24 days

Capacità di processo

Funzionalità di produzione di PCB

Conteggio strati: 1 strato-32 strati
Spessore rame finito □ 1 / 3oz-12oz
Larghezza min linea / spaziatura interna □ 3.0mil / 3.0mil
Larghezza min linea / spaziatura esterna: 4.0mil / 4.0mil
Rapporto di aspetto massimo: 10: 1
Spessore della scheda □ 0,2 mm-5,0 mm
Dimensione massima del pannello (pollici): 635 * 1500mm
Dimensione minima del foro: 4mil
Tolleranza del foro Plated: +/- 3mil
Blind / Buried Vias (tipi All): Sì
Via Fill (conduttivo, non conduttivo): Sì
Materiale base: FR-4, FR-4hg Tg. Materiale privo di alogeni, Rogers, Base in alluminio,poliimmide, Rame pesante
Finiture superficiali: HASL, OSP, ENIG, HAL-LF, argento mmmm,lmmersion Tin, dita d'oro, inchiostro al carbonio

Capacità di produzione SMT

Materiale PCB: FR-4, CEM-1, CEM-3, scheda a base di alluminio
Dimensione massima PCB: 510x460mm
Dimensioni min PCB: x 50x50mm
Spessore PCB 0,5 mm-4,5 mm
Spessore della scheda 0,5-4mm
Dimensioni min componenti: 0201
Componente di dimensioni del chip standard: 0603 e superiori
Altezza massima componente 15mm
Passo minimo di piombo: 0,3 mm
Passo palla BGA min: 0.4mm
Precisione di posizionamento: +/- 0,03 mm